

# DoC

We,

Company Name: Lightcomm Technology Co., Ltd.

Address: RM 1708-10, 17/F, PROSPERITY CENTRE, 25 CHONG YIP STREET, KWUN TONG,  
KOWLOON, HONG KONG

Postal/Zip: \_\_\_\_\_ City: \_\_\_\_\_ State/Province: \_\_\_\_\_ Country: HONG KONG

Contact Person:  Mr.  Ms. Name: Jiang Lin Huang Function: EMC Engineer

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declare for the equipment identified by:

Product Description MID

Type or Model(s) MID713-U, MID710-U, DL700D, DL700D(B), D2-741G\_XX(XX represents different color)

Tradename or Brand(s) \_\_\_\_\_

that:

**This device complies with Part 15 of the FCC Rules.**

**Operation is subject to the following two conditions:**

- (1) this device may not cause harmful interference, and**
- (2) this device must accept any interference received, including interference that may cause undesired operation.**

(if the DoC test reports are available at this moment, please cross item a below)

a). The following test reports, issued by an FCC accredited Laboratory, are subject to this declaration:

Accredited Test Firm or Laboratory name:	Test Report Number:	Date of issue:
_____	_____	_____
_____	_____	_____
_____	_____	_____

(if no DoC test report is available at this moment, then if you agree with the statement made in item b below, please cross item b below)

b). DoC testing is pending at this moment, but will execute and finish the required DoC testing in an FCC accredited Laboratory *before* marketing the device in the U.S. The following Accredited Test Firm will complete DoC testing:

Accredited Test Firm or Laboratory name:  
Compliance Certification Services Inc. (Tainan Lab.)

**Attestation:**

In addition to our declaration above, we also will ensure to label the equipment with the FCC logo, the name of the manufacturer and model number, as required by the [FCC rule part 15.19](#).

City and Country:	Date:	Name: <small>(this must be a person)</small>	Function:	Signature: <small>(or official company stamp)</small>
<u>Hongkong</u>	<u>06/05/2014</u>	<u>Jason Zeng</u>	<u>EMC Engineer</u>	